

■ FEATURES

- End stackable for standard 0.1" integrated circuit pitch.
- Molded 0.3" integrated circuit packing outline allowing automatic insertion.
- Smaller size makes better heat convection during PC board reflow wave soldering.
- Top tape sealed to withstand wave soldering, board washing.
- All plastics are UL 94V-0 grade fire retardant.
- Twin contacts designed to ensure stable contact.
- Gold plated contact to ensure low contact resistance and Tin plated terminal to prevent contamination during soldering.
- RoHS Compliant

APPLICATIONS

- Numerical setting for computer terminal equipment
- Price setting for vending machines
- Programming for game machines
- Programming for industrial equipment and measuring instruments

SPECIFICATIONS

1.ELECTRICAL

Contact rating	switching	25mA, 24VDC	
	non-switching	100mA	
Contact resistance	initial	50mΩ Max.	
	after life test	100mΩ Max.	
Insulation resistance		1000MΩ Min. at 100VDC	
Dielectric strength		500VDC Min. for 60 seconds	
Capacitance between adjacent switches 5pF Max.			

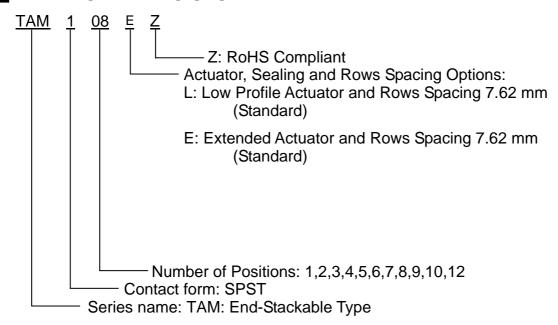




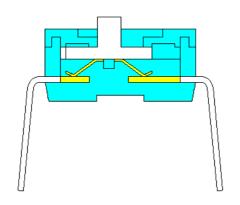
2.MECHANICAL and ENVIRONMENTAL

Temperature rating		
operating	-25°C to +70°C	
storage	-40°C to +85°C	
Operation force	800g Max.	
Mechanical life	2000 operations	
Humidity	95% RH, 40°C for 96 Hrs.	
Vibration	10Hz-55Hz-10Hz for 6 Hrs.	
Solderability	After flux 230±5℃ for 5±0.5 seconds, 95% coverage	
Resistance to soldering heat	260±5°C for 5±1 seconds.	

■ PART NUMBERING SYSTEM



■ CONSTRUCTION





Detec





■ DIMENSIONS AND CIRCUITRY

